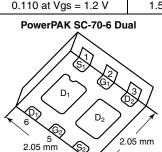
HALOGEN FREE



Vishay Siliconix

Dual N-Channel 8 V (D-S) MOSFET

PRODUCT SUMMARY									
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)						
8	0.027 at V _{GS} = 4.5 V	4.5							
	0.031 at V _{GS} = 2.5 V	4.5							
	0.036 at Vgs = 1.8 V	4.5	4.8 nC						
	0.047 at Vgs = 1.5 V								
	0.110 at Vgs = 1.2 V	1.5							



Ordering Information: SiA920DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

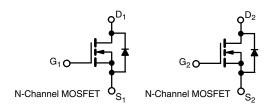
Marking Code СНХ Part # code X X XLot Traceability and Date code

FEATURES

- Halogen-free According to IEC 61249-2-21 **Definition**
- TrenchFET® Power MOSFET
- Thermally Enhanced PowerPAK® SC-70 Package
 - Small Footprint Area
 - Low On-Resistance
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Load Switch with Low Voltage Drop
- Load Switch for 1.2 V/1.5 V/1.8 V Power Lines
- Smart Phones, Tablet PCs, Portable Media Players



Parameter		Symbol	Limit	Unit			
Drain-Source Voltage		V_{DS}	8	V			
Gate-Source Voltage		V _{GS}	± 5	v			
Continuous Drain Current (T _J = 150 °C)	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$	I _D	4.5 ^a 4.5 ^a 4.5 ^{a, b, c} 4.5 ^{a, b, c}	A			
Pulsed Drain Current (t = 300 μs)		I _{DM}	20				
Continuous Source-Drain Diode Current	$T_C = 25 ^{\circ}C$ $T_A = 25 ^{\circ}C$	Is	4.5 ^a 1.6 ^{b, c}				
Maximum Power Dissipation	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$	P _D	7.8 5 1.9 ^{b, c} 1.2 ^{b, c}	w			
Operating Junction and Storage Temperatur	e Range	T _J , T _{stg}	- 55 to 150	°C			
Soldering Recommendations (Peak Tempera	ature) ^{d, e}		260				

THERMAL RESISTANCE RATINGS										
Parameter		Symbol	Typical	Maximum	Unit					
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	52	65	°C/W					
Maximum Junction-to-Case (Drain)	Steady State	R _{th.IC}	12.5	16	7 0/ **					

Notes:

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board.
- d. See solder profile (www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- Maximum under steady state conditions is 110 °C/W.

Document Number: 63299 S11-1381-Rev. A, 11-Jul-11 www.vishay.com

SiA920DJ

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	j - Cy	1000 0 0 110110		.,,,,	111,421	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	8			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			11		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 2.3		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	0.35		0.7	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$			± 100	nA
7 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		V _{DS} = 8 V, V _{GS} = 0 V			1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 8 V, V _{GS} = 0 V, T _J = 55 °C			10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10			Α
	, ,	$V_{GS} = 4.5 \text{ V}, I_D = 5.3 \text{ A}$		0.022	0.027	
		V _{GS} = 2.5 V, I _D = 4.9 A		0.025	0.031	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 1.8 V, I _D = 4.6 A		0.029	0.036	Ω
	= 5(51)	V _{GS} = 1.5 V, I _D = 1.5 A		0.035	0.047	
		V _{GS} = 1.2 V, I _D = 0.5 A		0.050	0.110	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 5.3 A		28		S
Dynamic ^b	l					
Input Capacitance	C _{iss}			470		pF
Output Capacitance	C _{oss}	V _{DS} = 4 V, V _{GS} = 0 V, f = 1 MHz		175		
Reverse Transfer Capacitance	C _{rss}			85		
Total Gate Charge	Q_g			4.8	7.5	
Gate-Source Charge	Q_{gs}	$V_{DS} = 4 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 6.9 \text{ A}$		0.63		nC
Gate-Drain Charge	Q_{gd}			0.6		
Gate Resistance	R_{g}	f = 1 MHz	0.8	4	8	Ω
Turn-On Delay Time	t _{d(on)}			5	10	
Rise Time	t _r	V 40V B 400		12	25	- ns
Turn-Off Delay Time	t _{d(off)}	V_{DD} = 10 V, R _L = 1.9 Ω $I_{D} \cong 5.5$ A, V_{GEN} = 4.5 V, R _a = 1 Ω		20	40	
Fall Time	t _f	D = 0.0 /1, *GEN = 1.0 *, rig = 1.22		7	15	
Drain-Source Body Diode Characteristic	s	T _C = 25 °C				
Continuous Source-Drain Diode Current	ontinuous Source-Drain Diode Current I _S				4.5	A
Pulse Diode Forward Current	I _{SM}				20	
Body Diode Voltage	V_{SD}	I _S = 5.5 A, V _{GS} = 0 V		0.8	1.2	V
Body Diode Reverse Recovery Time t _{rr}				15	30	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 5.5 A, dI/dt = 100 A/μs, T _J = 25 °C		5	10	nC
Reverse Recovery Fall Time	t _a	i _F = 3.3 A, αι/αι = 100 A/μs, 1 _J = 25 C		7.8		20
Reverse Recovery Rise Time	t _b			7.2		ns

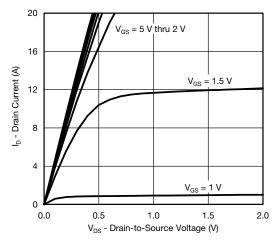
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

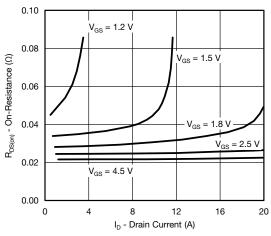


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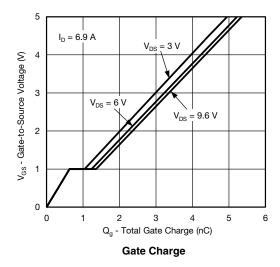
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

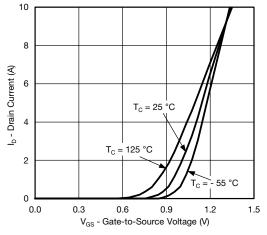


Output Characteristics

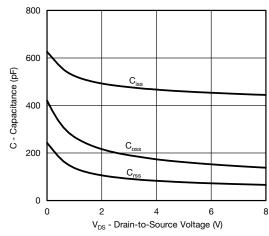


On-Resistance vs. Drain Current and Gate Voltage

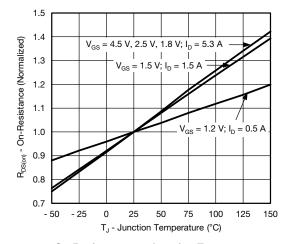




Transfer Characteristics



Capacitance

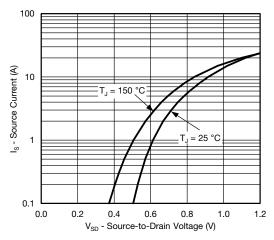


On-Resistance vs. Junction Temperature

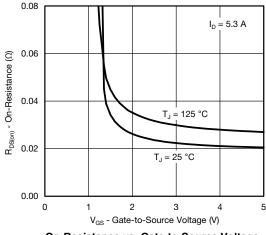
SiA920DJ

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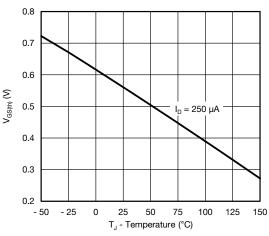
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



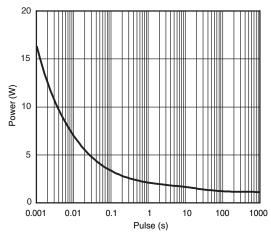
Source-Drain Diode Forward Voltage



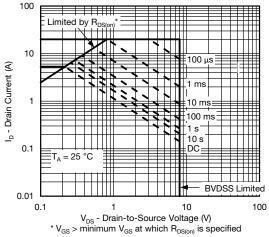
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power (Junction-to-Ambient)



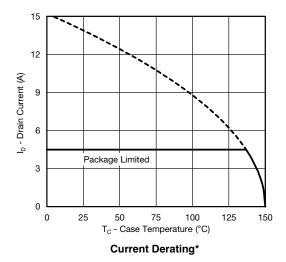
Safe Operating Area, Junction-to-Ambient

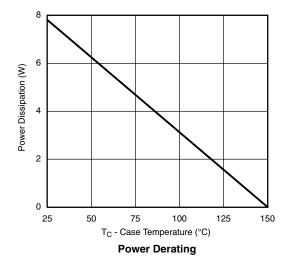




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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





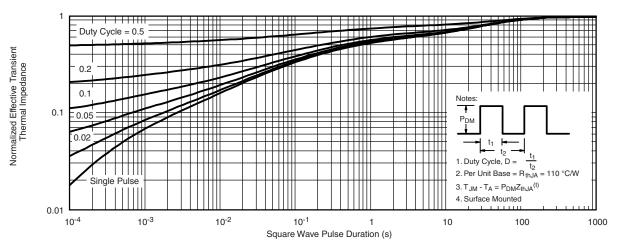
 $^{^*}$ The power dissipation P_D is based on $T_{J(max)}$ = 150 $^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

SiA920DJ

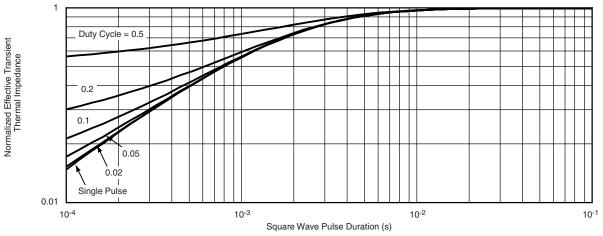
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

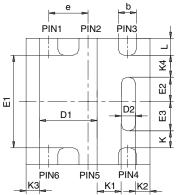


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63299.

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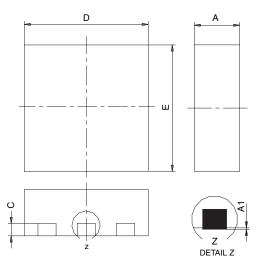
PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

	SINGLE PAD						DUAL PAD						
DIM	M	ILLIMETER	RS	INCHES			MILLIMETERS			INCHES			
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032	
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002	
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015	
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010	
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028	
D2	0.135	0.235	0.335	0.005	0.009	0.013							
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041	
E2	0.345	0.395	0.445	0.014	0.016	0.018							
E3	0.425	0.475	0.525	0.017	0.019	0.021							
е		0.65 BSC			0.026 BSC			0.65 BSC			0.026 BSC		
K		0.275 TYP	1		0.011 TYP	1	0.275 TYP		0.011 TYP				
K1		0.400 TYP	1		0.016 TYP			0.320 TYP		0.013 TYP			
K2		0.240 TYP	1		0.009 TYP			0.252 TYP		0.010 TYP			
К3		0.225 TYP	1	0.009 TYP									
K4		0.355 TYP		0.014 TYP									
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015	
Т							0.05	0.10	0.15	0.002	0.004	0.006	
FCN: C-07431 - Rev. C. 06-Aug-07													

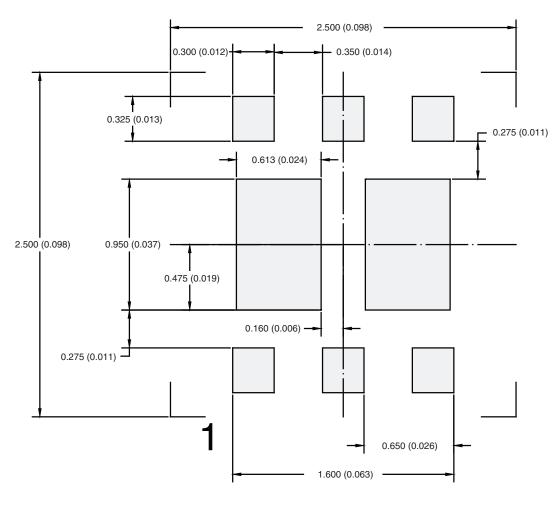
DWG: 5934

Document Number: 73001 06-Aug-07

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RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

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